# MSKSEMI















**ESD** 

**TVS** 

**TSS** 

MOV

**GDT** 

**PLED** 

Broduct data speet



Semiconductor

#### Compiance

## **Features**

- Solid-state silicon-avalanche technology
- Low operating and clamping voltage
- Up to four I/O Lines of Protection
- Ultra low capacitance: 0.3pF typical(I/O to I/O)
- Low Leakage
- Low operating voltage:5V
- Flow-Through design

# IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 5A (8/20μs)

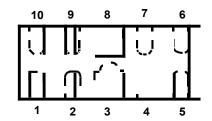
## **Mechanical Characteristics**

- DFN2510-10L
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

# **Applications**

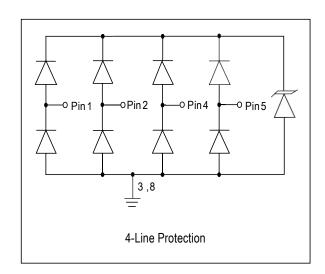
- Digital Visual Interface(DVI)
- MDDI Ports
- DisplayPortTM Interface
- PCI Express
- High Definition Multi-Media Interface(HDMI)
- eSATA Interfaces

## DFN2510-10L



Pin	Identificaion
1,2,4,5	Input Lines
6,7,9,10	Output Lines (No Internal Connection)
3,8	Ground

# **Circuit Diagram**



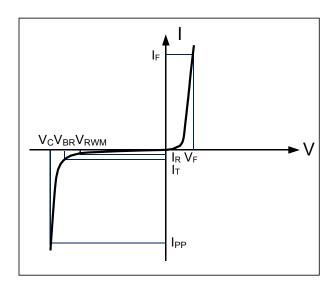


# **Absolute Maximum Rating**

Rating	Symbol	Value	Units
Peak Pulse Power ( t <sub>p</sub> =8/20μs )	P <sub>PP</sub>	150	Watts
Peak Pulse Current ( t <sub>p</sub> =8/20μs )	I <sub>pp</sub>	5	А
ESD per IEC 61000-4-2(Air) ESD per IEC 61000-4-2(contact)	V <sub>ESD</sub>	+/-17 +/-12	kV
Operating Temperature	TJ	-55 to + 125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

# **Electrical Parameters (T=25°C)**

Symbol	Parameter
<b>I</b> PP	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
IR	Maximum Reverse Leakage Current @ VRWM
V <sub>BR</sub>	Breakdown Voltage @ Ιτ
lτ	Test Current
lF	Forward Current
VF	Forward Voltage @ I <sub>F</sub>

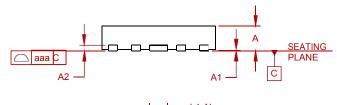


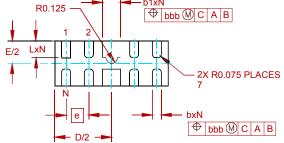
# **Electrical Characteristics**

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	Any I/O pin to ground			5.0	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>t</sub> = 1mA Any I/O pin to ground	6.0			V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V, T=25°C Any I/O pin to ground			1	μA
Clamping Voltage	Vc	I <sub>pp</sub> =5A, t <sub>p</sub> =8/20µs Any I/O pin to ground			15	V
		V <sub>R</sub> = 0V, f = 1MHz I/O pin to GND			0.8	pF
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = 0V, f = 1MHz Between I/O pins		0.3		pF

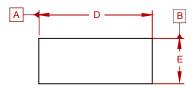


## **PACKAGE MECHANICAL DATA**



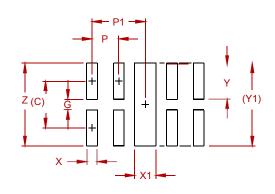


Dimensions in millimeters



DIMENSI ONS						
DIM INCHES		MILLIN	MILLIMETERS			
J	MIN	NOM	MAX	MIN	NOM	MAX
Α	.020	.023	.026	0.50	0.58	0.65
A1	0.00	.001	.002	0.00	0.03	0.05
A2	(.005)		(0	).13)		
b	.006	.008	.010	0.15	0.20	0.25
b1	.014	.016	.018	0.35	0.40	0.45
D	.094	.098	.102	2.40	2.50	2.60
E	.035	.039	.043	0.90	1.00	1.10
е	.020 BSC		0.50	BSC		
L	.012	.015	.017	0.30	0.38	0.425
N	8		8			
aaa	.003		0.08			
bbb	.004		0.10			

## **Suggested Pad Layout**



DIMENSIONS		
DIM	INCHES	MILLIMETERS
С	(.034)	(0.875)
G	.008	0.20
Р	.020	0.50
P1	.039	1.00
Х	.008	0.20
X1	.016	0.40
Υ	.027	0.675
Y1	(.061)	(1.55)
Z	.061	1.55

#### NOTES:

CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES). THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

## **REEL SPECIFICATION**

P/N	PKG	QTY
ESDA6V8UD-MS	DFN2510-10L	3000



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